

Amendments to the Specification

Please amend the TITLE to read as follows:

"SURFACE MOUNT TECHNOLOGY EVALUATION BOARD HAVING VARIED BOARD PAD CHARACTERISTICS"

Please replace paragraph [0027] with the following amended paragraph:

[0027] Figures 4a-4e are a series of diagrams showing several cases of solder paste deposition on a board pad; ~~and,~~

Please replace paragraph [0028] with the following amended paragraph:

[0028] Figures 5a-5g are a series of diagrams showing several different embodiments for the board pads on the evaluation board; ~~and-~~

Please add the following new paragraph after paragraph [0028]:

[0028.1] Figures 6a-6c are a series of diagrams showing views of top and bottom surfaces of a double-sided evaluation board in accordance with several different embodiments of the invention.

Please replace paragraph [0035] with the following amended paragraph:

[0035] An evaluation board may have the board pad patterns of evaluation board **10** or evaluation board **20** on a single surface. Alternatively, an evaluation board **50** may be double sided and have the board pad patterns of evaluation board **10** on each surface (e.g. Figure 6a), the board pad patterns of evaluation board **20** on each surface (e.g. Figure 6b), or the board pad patterns of evaluation board **10** on one of the surfaces and the board pad patterns of evaluation board **20** on the other surface (e.g. Figure 6c).